

# **HTT1127E**

# Silicon NPN Epitaxial Twin Transistor

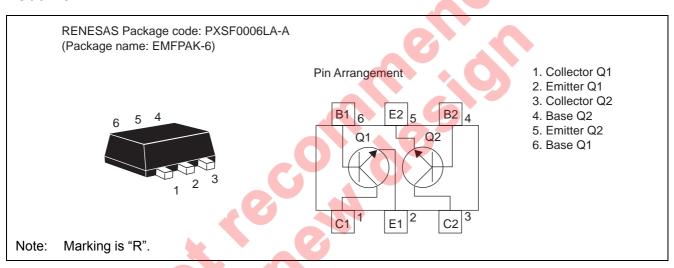
REJ03G0839-0100 (Previous ADE-208-1540) Rev.1.00 Aug.10.2005

#### **Features**

• Include 2 transistors in a small size SMD package: EMFPAK-6 (6 Leads: 1.2 x 0.8 x 0.5 mm)

Q1: Equivalent Buffer transistor	Q2: Equivalent OSC transistor				
2SC5700	2SC5849				

#### **Outline**

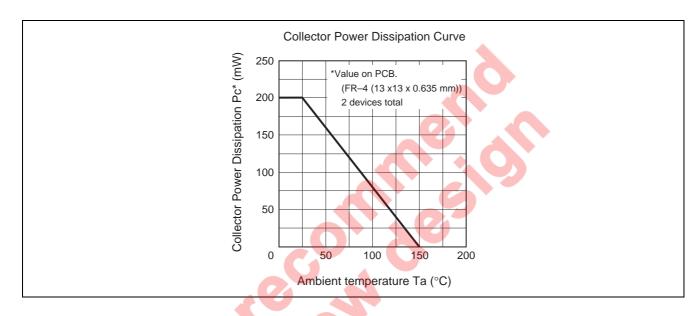


# **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Rat	Ratings		
item	- Cymbol	Q1	Q2	Unit	
Collector to base voltage	V <sub>CBO</sub>	15	15	V	
Collector to emitter voltage	V <sub>CEO</sub>	4	6	V	
Emitter to base voltage	V <sub>EBO</sub>	1.5	1.5	V	
Collector current	lc	50	80	mA	
Collector power dissipation	Pc	Tota	Total 200*		
Junction temperature	Tj	150	150	°C	
Storage temperature	Tstg	-55 to +150	-50 to +150	°C	

Note: \*Value on PCB. (FR-4 (13 x 13 x 0.635 mm)).



### **Q1 Electrical Characteristics**

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	_	_	V	$I_C = 10 \mu\text{A},  I_E = 0$
Collector cutoff current	I <sub>CBO</sub>	_		0.1	μΑ	$V_{CB} = 15 \text{ V}, I_{E} = 0$
Collector cutoff current	I <sub>CEO</sub>	_	_	1.0	μΑ	V <sub>CE</sub> = 4 V, R <sub>BE</sub> = infinite
Emitter cutoff current	I <sub>EBO</sub>	_		0.1	μΑ	$V_{EB} = 0.8 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub>	100	120	150	_	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}$
Reverse transfer capacitance	C <sub>re</sub>	_	0.3	0.45	pF	V <sub>CB</sub> = 1 V, f = 1 MHz Emitter ground
Gain bandwidth product	f⊤	10	12	_	GHz	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 5 mA, f = 1 GHz
Forward transfer coefficient	$ S_{21} ^2$	13	16	_	dB	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA},$
Noise figure	NF	_	1.0	1.7	dB	f = 900 MHz, $\Gamma_S = \Gamma_L = 50 \Omega$

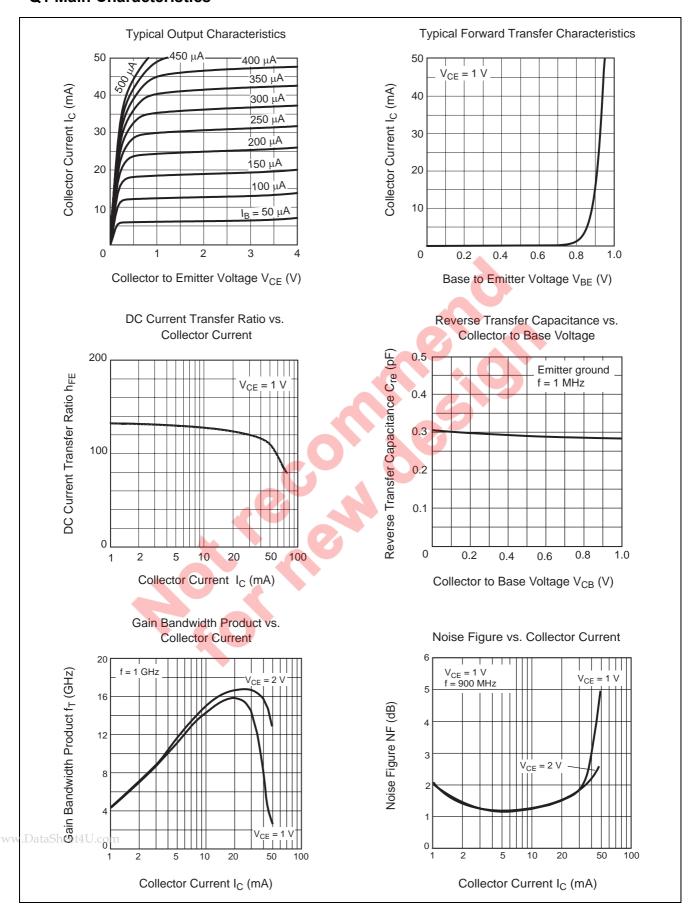
### **Q2 Electrical Characteristics**

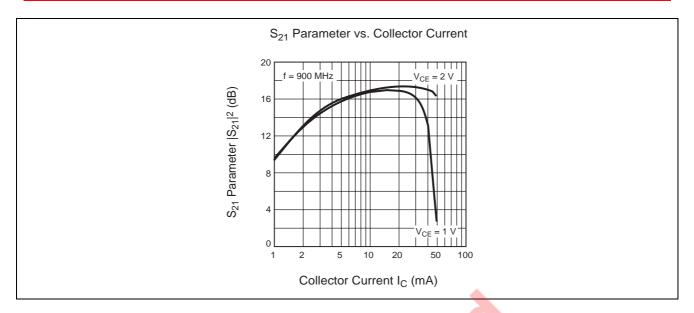
 $(Ta = 25^{\circ}C)$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	15	_		V	$I_C = 10 \mu\text{A}, I_E = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	0.1	μΑ	$V_{CB} = 15 \text{ V}, I_{E} = 0$
Collector cutoff current	I <sub>CEO</sub>	_	-	0.1	μΑ	V <sub>CE</sub> = 4 V, R <sub>BE</sub> = infinite
Emitter cutoff current	I <sub>EBO</sub>	_	(-)	0.1	μΑ	$V_{EB} = 1.5 \text{ V}, I_{C} = 0$
DC current transfer ratio	h <sub>FE</sub>	90	120	140		$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA}$
Reverse transfer capacitance	C <sub>re</sub>		0.50	0.65	pF	V <sub>CB</sub> = 1 V, f = 1 MHz
						Emitter ground
Gain bandwidth product	f <sub>T</sub>	2.0	4.0		GHz	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA},$
						f = 1 GHz
Forward transfer coefficient	$ S_{21} ^2$	7	11	_	dB	$V_{CE} = 1 \text{ V}, I_{C} = 5 \text{ mA},$
Noise figure	NF		1.7	2.3	dB	f = 900 MHz
						$\Gamma_{\rm S} = \Gamma_{\rm L} = 50 \ \Omega$



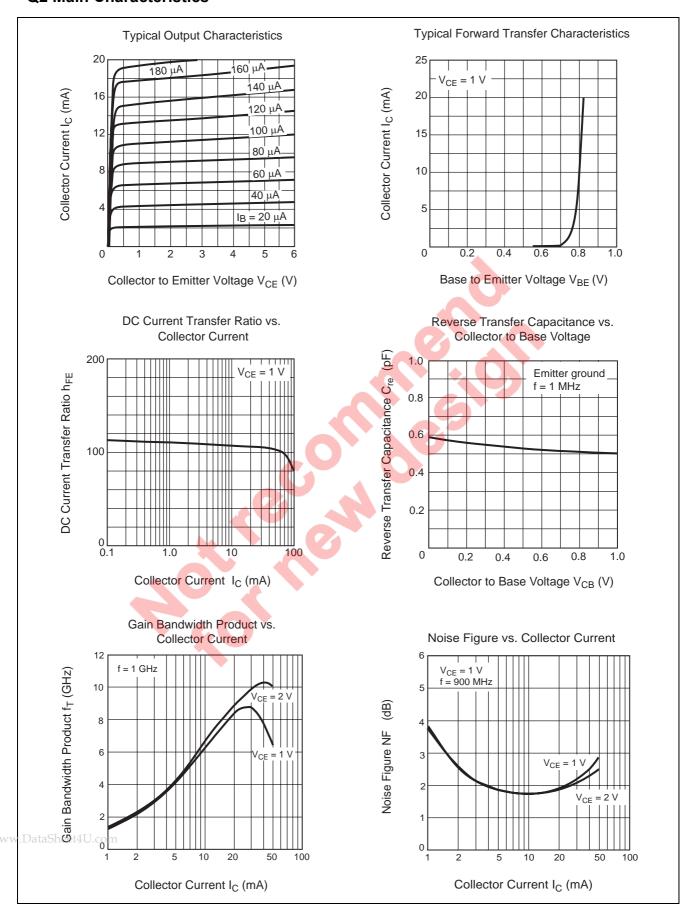
#### **Q1 Main Characteristics**

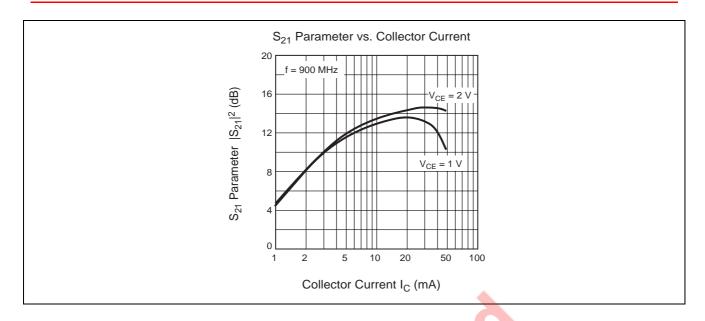






#### **Q2 Main Characteristics**

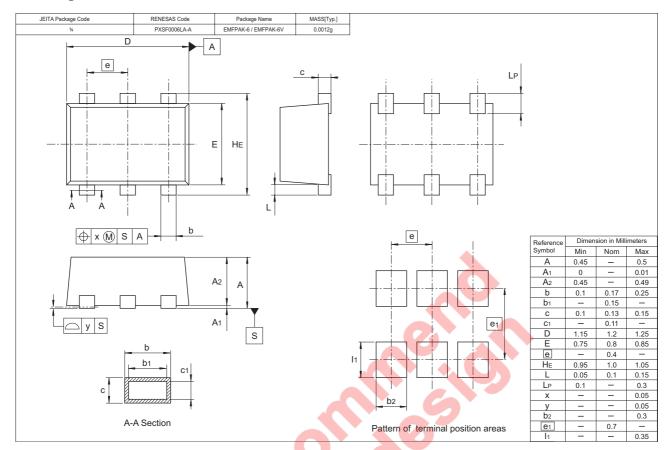






TATALAN DataShoot/III.com

# **Package Dimensions**



# **Ordering Information**

Part Name	Quantity		Shipping Container
HTT1127ERTL-E	5000	φ 178	8 mm Reel, 8 mm Emboss Taping

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Renesas Technology Malaysia Sdn. Bhd.

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